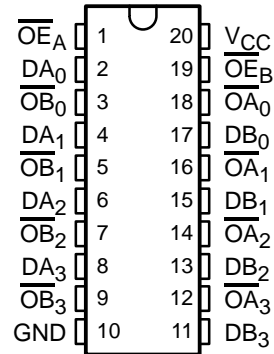


# CY54FCT240T, CY74FCT240T 8-BIT BUFFERS/LINE DRIVERS WITH 3-STATE OUTPUTS

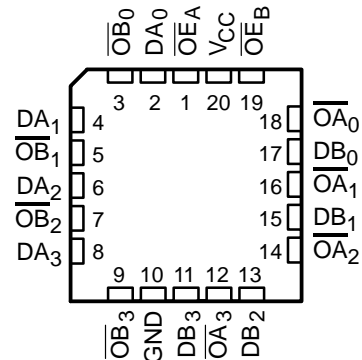
SCCS017A – MAY 1994 – REVISED OCTOBER 2001

- Function, Pinout, and Drive Compatible With FCT and F Logic
- Reduced  $V_{OH}$  (Typically = 3.3 V) Versions of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- Matched Rise and Fall Times
- Fully Compatible With TTL Input and Output Logic Levels
- CY54FCT240T
  - 48-mA Output Sink Current
  - 12-mA Output Source Current
- CY74FCT240T
  - 64-mA Output Sink Current
  - 32-mA Output Source Current
- 3-State Outputs

CY54FCT240T . . . D PACKAGE  
CY74FCT240T . . . Q OR SO PACKAGE  
(TOP VIEW)



CY54FCT240T . . . L PACKAGE  
(TOP VIEW)



## description

The 'FCT240T devices are octal buffers and line drivers designed to be employed as memory address drivers, clock drivers, and bus-oriented transmitters/receivers. These devices provide speed and drive capabilities equivalent to their fastest bipolar logic counterparts, while reducing power consumption. The input and output voltage levels allow direct interface with TTL, NMOS, and CMOS devices without external components.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**ORDERING INFORMATION**

| T <sub>A</sub> | PACKAGE†      |               | SPEED (ns)      | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|---------------|---------------|-----------------|-----------------------|------------------|
| -40°C to 85°C  | SOIC – SO     | Tube          | 4.3             | CY74FCT240CTSOC       | FCT240C          |
|                |               | Tape and reel | 4.3             | CY74FCT240CTSUCT      |                  |
|                | QSOP – Q      | Tape and reel | 4.3             | CY74FCT240CTQCT       | FCT240C          |
|                | SOIC – SO     | Tube          | 4.8             | CY74FCT240ATSOC       | FCT240A          |
|                |               | Tape and reel | 4.8             | CY74FCT240ATSUCT      |                  |
|                | QSOP – Q      | Tape and reel | 4.8             | CY74FCT240ATQCT       | FCT240A          |
|                | SOIC – SO     | Tube          | 8               | CY74FCT240TSOC        | FCT240           |
| Tape and reel  |               | 8             | CY74FCT240TSUCT |                       |                  |
| QSOP – Q       | Tape and reel | 8             | CY74FCT240TQCT  | FCT240                |                  |
| -55°C to 125°C | CDIP – D      | Tube          | 4.7             | CY54FCT240CTDMB       |                  |
|                | CDIP – D      | Tube          | 5.1             | CY54FCT240ATDMB       |                  |
|                | LCC – L       | Tube          | 5.1             | CY54FCT240ATLMB       |                  |
|                | CDIP – D      | Tube          | 9               | CY54FCT240TDMB        |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

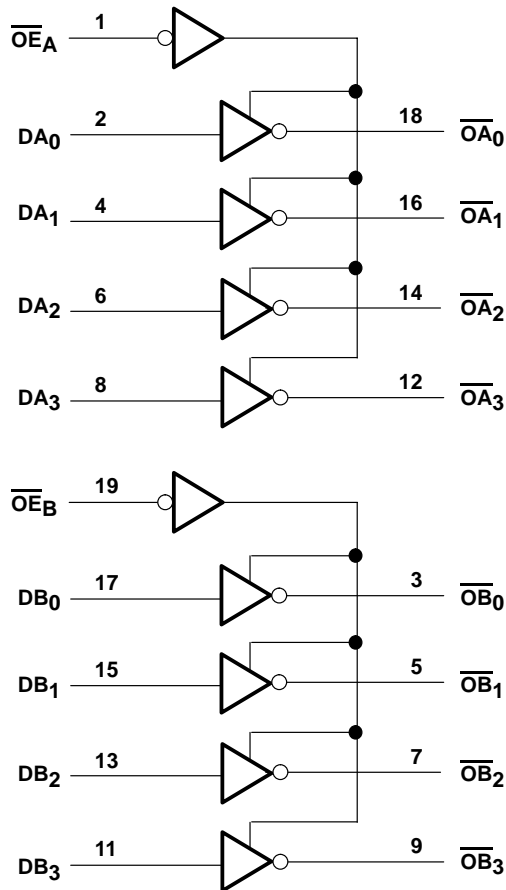
**FUNCTION TABLE**

| INPUTS            |                   |   | OUTPUT<br>O |
|-------------------|-------------------|---|-------------|
| $\overline{OE}_A$ | $\overline{OE}_B$ | D |             |
| L                 | L                 | L | H           |
| L                 | L                 | H | L           |
| H                 | H                 | X | Z           |

H = High logic level, L = Low logic level,  
X = Don't care, Z = High-impedance state



**logic diagram (positive logic)**



**absolute maximum rating over operating free-air temperature range (unless otherwise noted)†**

|  |                |
|--|----------------|
| Supply voltage range to ground potential .....                         | -0.5 V to 7 V  |
| DC input voltage range .....   | -0.5 V to 7 V  |
| DC output voltage range .....  | -0.5 V to 7 V  |
| DC output current (maximum sink current/pin) .....                     | 120 mA         |
| Package thermal impedance, $\theta_{JA}$ (see Note 1): Q package ..... | 68°C/W         |
| SO package .....   | 58°C/W         |
| Ambient temperature range with power applied, $T_A$ .....              | -65°C to 135°C |
| Storage temperature range, $T_{Stg}$ .....                             | -65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**recommended operating conditions (see Note 2)**

|   | CY54FCT240T |     |     | CY74FCT240T |     |      | UNIT |
|---|-------------|-----|-----|-------------|-----|------|------|
|   | MIN         | NOM | MAX | MIN         | NOM | MAX  |      |
| V <sub>CC</sub> Supply voltage                | 4.5         | 5   | 5.5 | 4.75        | 5   | 5.25 | V    |
| V <sub>IH</sub> High-level input voltage      | 2           |     |     | 2           |     |      | V    |
| V <sub>IL</sub> Low-level input voltage       |             |     | 0.8 |             |     | 0.8  | V    |
| I <sub>OH</sub> High-level output current     |             |     | -12 |             |     | -32  | mA   |
| I <sub>OL</sub> Low-level output current      |             |     | 48  |             |     | 64   | mA   |
| T <sub>A</sub> Operating free-air temperature | -55         |     | 125 | -40         |     | 85   | °C   |

NOTE 2: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.



**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER          | TEST CONDITIONS  | CY54FCT240T              |      | CY74FCT240T |               | UNIT       |      |
|--------------------|--|--------------------------|------|-------------|---------------|------------|------|
|                    |  | MIN                      | TYP† | MAX         | MIN           |            | TYP† |
| V <sub>IK</sub>    | V <sub>CC</sub> = 4.5 V, I <sub>IN</sub> = -18 mA  | -0.7                     | -1.2 |             |               | V          |      |
|                    | V <sub>CC</sub> = 4.75 V, I <sub>IN</sub> = -18 mA   |                          |      |             | -0.7 -1.2     |            |      |
| V <sub>OH</sub>    | V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -12 mA  | 2.4                      | 3.3  |             |               | V          |      |
|                    | V <sub>CC</sub> = 4.75 V   | I <sub>OH</sub> = -32 mA |      |             | 2             |            |      |
|                    |  | I <sub>OH</sub> = -15 mA |      |             | 2.4           |            | 3.3  |
| V <sub>OL</sub>    | V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 48 mA   | 0.3                      | 0.55 |             |               | V          |      |
|                    | V <sub>CC</sub> = 4.75 V, I <sub>OL</sub> = 64 mA  |                          |      |             | 0.3 0.55      |            |      |
| V <sub>hys</sub>   | All inputs   | 0.2                      |      |             | 0.2           | V          |      |
| I <sub>I</sub>     | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = V <sub>CC</sub>   |                          |      | 5           |               | μA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>IN</sub> = V <sub>CC</sub>  |                          |      |             | 5             |            |      |
| I <sub>IH</sub>    | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 2.7 V   |                          |      | ±1          |               | μA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>IN</sub> = 2.7 V  |                          |      |             | ±1            |            |      |
| I <sub>IL</sub>    | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0.5 V   |                          |      | ±1          |               | μA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>IN</sub> = 0.5 V  |                          |      |             | ±1            |            |      |
| I <sub>OZH</sub>   | V <sub>CC</sub> = 5.5 V, V <sub>OUT</sub> = 2.7 V  |                          |      | 10          |               | μA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>OUT</sub> = 2.7 V   |                          |      |             | 10            |            |      |
| I <sub>OZL</sub>   | V <sub>CC</sub> = 5.5 V, V <sub>OUT</sub> = 0.5 V  |                          |      | -10         |               | μA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>OUT</sub> = 0.5 V   |                          |      |             | -10           |            |      |
| I <sub>OS</sub> ‡  | V <sub>CC</sub> = 5.5 V, V <sub>OUT</sub> = 0 V  | -60                      | -120 | -225        |               | mA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>OUT</sub> = 0 V   |                          |      |             | -60 -120 -225 |            |      |
| I <sub>off</sub>   | V <sub>CC</sub> = 0 V, V <sub>OUT</sub> = 4.5 V  |                          |      | ±1          |               | μA         |      |
| I <sub>CC</sub>    | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> ≤ 0.2 V, V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V  | 0.1                      | 0.2  |             |               | mA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>IN</sub> ≤ 0.2 V, V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V   |                          |      |             | 0.1 0.2       |            |      |
| ΔI <sub>CC</sub>   | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 3.4 V§, f <sub>1</sub> = 0, Outputs open  | 0.5                      | 2    |             |               | mA         |      |
|                    | V <sub>CC</sub> = 5.25 V, V <sub>IN</sub> = 3.4 V§, f <sub>1</sub> = 0, Outputs open   |                          |      |             | 0.5 2         |            |      |
| I <sub>CCD</sub> ¶ | V <sub>CC</sub> = 5.5 V, One input switching at 50% duty cycle, Outputs open, $\overline{OE}_A = \overline{OE}_B = \text{GND}$ , V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V  | 0.06                     | 0.12 |             |               | mA/<br>MHz |      |
|                    | V <sub>CC</sub> = 5.25 V, One input switching at 50% duty cycle, Outputs open, $\overline{OE}_A = \overline{OE}_B = \text{GND}$ , V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V |                          |      |             | 0.06 0.12     |            |      |

† Typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

§ Per TTL-driven input (V<sub>IN</sub> = 3.4 V); all other inputs at V<sub>CC</sub> or GND

¶ This parameter is derived for use in total power-supply calculations.



**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)**

| PARAMETER        | TEST CONDITIONS  |   | CY54FCT240T   |      | CY74FCT240T |     | UNIT |
|------------------|--|---|---|------|-------------|-----|------|
|                  |  |   | MIN   | TYP† | MAX         | MIN |      |
| I <sub>C</sub> # | V <sub>CC</sub> = 5.5 V,<br>Outputs open,<br>$\overline{OE}_A = \overline{OE}_B = \text{GND}$  | One bit switching<br>at f <sub>1</sub> = 10 MHz<br>at 50% duty cycle        | V <sub>IN</sub> ≤ 0.2 V or<br>V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V | 0.7  | 1.4         |     |      |
|                  |  |   | V <sub>IN</sub> = 3.4 V or GND  | 1    | 2.4         |     |      |
|                  |  | Eight bits<br>switching<br>at f <sub>1</sub> = 2.5 MHz<br>at 50% duty cycle | V <sub>IN</sub> = 0.2 V or<br>V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V | 1.3  | 2.6         |     |      |
|                  |  |   | V <sub>IN</sub> = 3.4 V or GND  | 3.3  | 10.6        |     |      |
|                  | V <sub>CC</sub> = 5.25 V,<br>Outputs open,<br>$\overline{OE}_A = \overline{OE}_B = \text{GND}$ | One bit switching<br>at f <sub>1</sub> = 10 MHz<br>at 50% duty cycle        | V <sub>IN</sub> ≤ 0.2 V or<br>V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V |      |             | 0.7 | 1.4  |
|                  |  |   | V <sub>IN</sub> = 3.4 V or GND  |      |             | 1   | 2.4  |
|                  |  | Eight bits<br>switching<br>at f <sub>1</sub> = 2.5 MHz<br>at 50% duty cycle | V <sub>IN</sub> = 0.2 V or<br>V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V |      |             | 1.3 | 2.6  |
|                  |  |   | V <sub>IN</sub> = 3.4 V or GND  |      |             | 3.3 | 10.6 |
| C <sub>i</sub>   |  |   | 5   | 10   | 5           | 10  | pF   |
| C <sub>o</sub>   |  |   | 9   | 12   | 9           | 12  | pF   |

† Typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

# I<sub>C</sub> = I<sub>CC</sub> + ΔI<sub>CC</sub> × D<sub>H</sub> × N<sub>T</sub> + I<sub>CCD</sub> (f<sub>0</sub>/2 + f<sub>1</sub> × N<sub>1</sub>)

Where:

I<sub>C</sub> = Total supply current

I<sub>CC</sub> = Power-supply current with CMOS input levels

ΔI<sub>CC</sub> = Power-supply current for a TTL high input (V<sub>IN</sub> = 3.4 V)

D<sub>H</sub> = Duty cycle for TTL inputs high

N<sub>T</sub> = Number of TTL inputs at D<sub>H</sub>

I<sub>CCD</sub> = Dynamic current caused by an input transition pair (HLH or LHL)

f<sub>0</sub> = Clock frequency for registered devices, otherwise zero

f<sub>1</sub> = Input signal frequency

N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the I<sub>CC</sub> formula.



**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**switching characteristics over operating free-air temperature range (see Figure 1)**

| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | CY54FCT240T |      | CY54FCT240AT |     | CY54FCT240CT |     | UNIT |
|------------------|-----------------|-------------|-------------|------|--------------|-----|--------------|-----|------|
|                  |                 |             | MIN         | MAX  | MIN          | MAX | MIN          | MAX |      |
| t <sub>PLH</sub> | D               | $\bar{O}$   | 1.5         | 9    | 1.5          | 5.1 | 1.5          | 4.7 | ns   |
| t <sub>PHL</sub> |                 |             | 1.5         | 9    | 1.5          | 5.1 | 1.5          | 4.7 |      |
| t <sub>PZH</sub> | $\overline{OE}$ | $\bar{O}$   | 1.5         | 10.5 | 1.5          | 6.5 | 1.5          | 5.7 | ns   |
| t <sub>PZL</sub> |                 |             | 1.5         | 10.5 | 1.5          | 6.5 | 1.5          | 5.7 |      |
| t <sub>PHZ</sub> | $\overline{OE}$ | $\bar{O}$   | 1.5         | 10   | 1.5          | 5.9 | 1.5          | 4.6 | ns   |
| t <sub>PLZ</sub> |                 |             | 1.5         | 10   | 1.5          | 5.9 | 1.5          | 4.6 |      |

**switching characteristics over operating free-air temperature range (see Figure 1)**

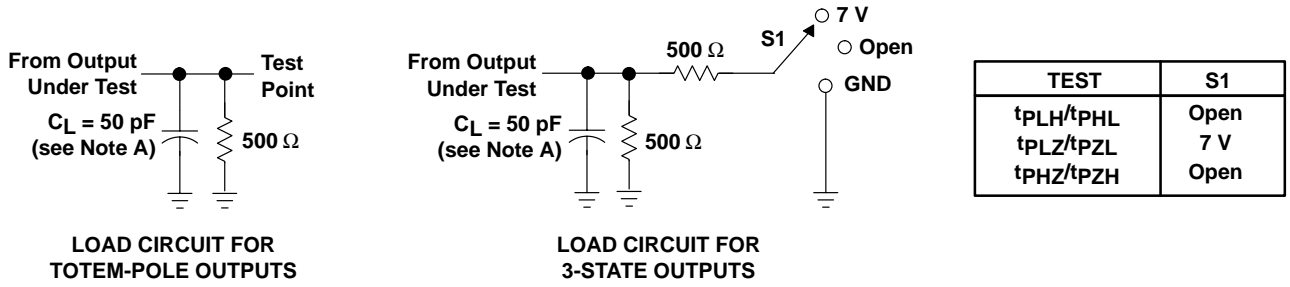
| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | CY74FCT240T |     | CY74FCT240AT |     | CY74FCT240CT |     | UNIT |
|------------------|-----------------|-------------|-------------|-----|--------------|-----|--------------|-----|------|
|                  |                 |             | MIN         | MAX | MIN          | MAX | MIN          | MAX |      |
| t <sub>PLH</sub> | D               | $\bar{O}$   | 1.5         | 8   | 1.5          | 4.8 | 1.5          | 4.3 | ns   |
| t <sub>PHL</sub> |                 |             | 1.5         | 8   | 1.5          | 4.8 | 1.5          | 4.3 |      |
| t <sub>PZH</sub> | $\overline{OE}$ | $\bar{O}$   | 1.5         | 10  | 1.5          | 6.2 | 1.5          | 5   | ns   |
| t <sub>PZL</sub> |                 |             | 1.5         | 10  | 1.5          | 6.2 | 1.5          | 5   |      |
| t <sub>PHZ</sub> | $\overline{OE}$ | $\bar{O}$   | 1.5         | 9.5 | 1.5          | 5.6 | 1.5          | 4.5 | ns   |
| t <sub>PLZ</sub> |                 |             | 1.5         | 9.5 | 1.5          | 5.6 | 1.5          | 4.5 |      |



**CY54FCT240T, CY74FCT240T**  
**8-BIT BUFFERS/LINE DRIVERS**  
**WITH 3-STATE OUTPUTS**

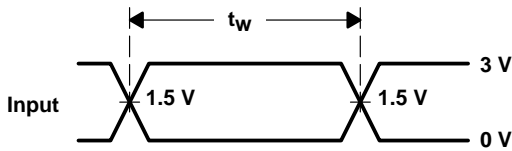
SCCS017A – MAY 1994 – REVISED OCTOBER 2001

**PARAMETER MEASUREMENT INFORMATION**

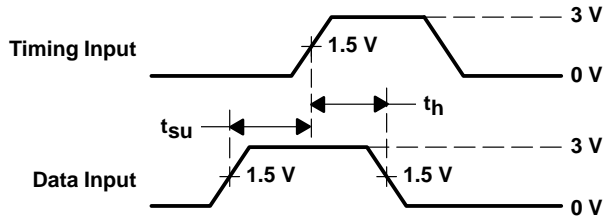


**LOAD CIRCUIT FOR TOTEM-POLE OUTPUTS**

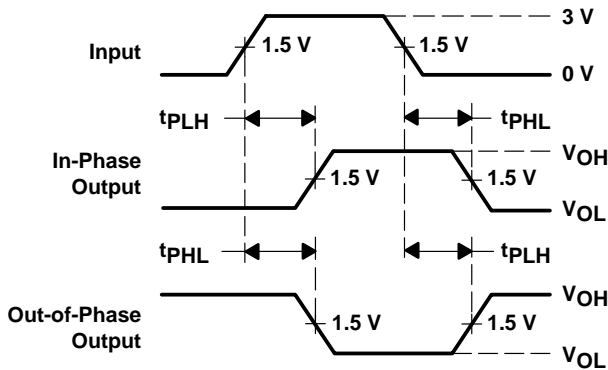
**LOAD CIRCUIT FOR 3-STATE OUTPUTS**



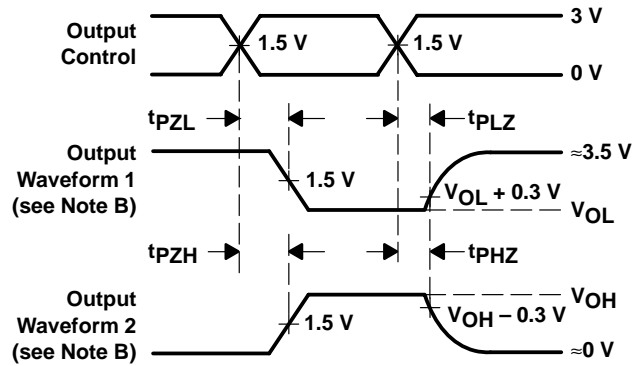
**VOLTAGE WAVEFORMS PULSE DURATION**



**VOLTAGE WAVEFORMS SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS**



**VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING**

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. The outputs are measured one at a time with one input transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**



**PACKAGING INFORMATION**

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                        |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|--|
| <a href="#">5962-9221301MRA</a>    | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9221301MR<br>A                        |
| <a href="#">5962-9221303M2A</a>    | Active        | Production           | LCCC (FK)   20  | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9221303M2A<br>CY54FCT<br>240ATLMB |
| <a href="#">5962-9221303MRA</a>    | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9221303MR<br>A<br>CY54FCT240ATDM<br>B |
| <a href="#">5962-9221305MRA</a>    | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9221305MR<br>A                        |
| <a href="#">CY54FCT240ATDMB</a>    | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9221303MR<br>A<br>CY54FCT240ATDM<br>B |
| <a href="#">CY54FCT240ATLMB</a>    | Active        | Production           | LCCC (FK)   20  | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9221303M2A<br>CY54FCT<br>240ATLMB |
| <a href="#">CY74FCT240ATQCT</a>    | Active        | Production           | SSOP (DBQ)   20 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240ATQCT.B</a>  | Active        | Production           | SSOP (DBQ)   20 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240ATSOC</a>    | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240ATSOC.B</a>  | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240ATSOCT</a>   | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240ATSOCT.B</a> | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240A                                    |
| <a href="#">CY74FCT240TQCT</a>     | Active        | Production           | SSOP (DBQ)   20 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TQCT.B</a>   | Active        | Production           | SSOP (DBQ)   20 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TSOC</a>     | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TSOC.B</a>   | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TSOCT</a>    | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TSOCT.B</a>  | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240                                     |
| <a href="#">CY74FCT240TSOCTG4</a>  | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240                                     |

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CY74FCT240TSOCTG4.B   | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | FCT240              |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CY74FCT240ATQCT   | SSOP         | DBQ             | 20   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| CY74FCT240ATSOCT  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CY74FCT240TQCT    | SSOP         | DBQ             | 20   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| CY74FCT240TSOCT   | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CY74FCT240TSOCTG4 | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CY74FCT240ATQCT   | SSOP         | DBQ             | 20   | 2500 | 353.0       | 353.0      | 32.0        |
| CY74FCT240ATSOCT  | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| CY74FCT240TQCT    | SSOP         | DBQ             | 20   | 2500 | 353.0       | 353.0      | 32.0        |
| CY74FCT240TSOCT   | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| CY74FCT240TSOCTG4 | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |

**TUBE**


\*All dimensions are nominal

| Device            | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9221303M2A   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| CY54FCT240ATLMB   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| CY74FCT240ATSOC   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| CY74FCT240ATSOC.B | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| CY74FCT240TSOC    | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| CY74FCT240TSOC.B  | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |

# J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## GENERIC PACKAGE VIEW

**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.



# EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

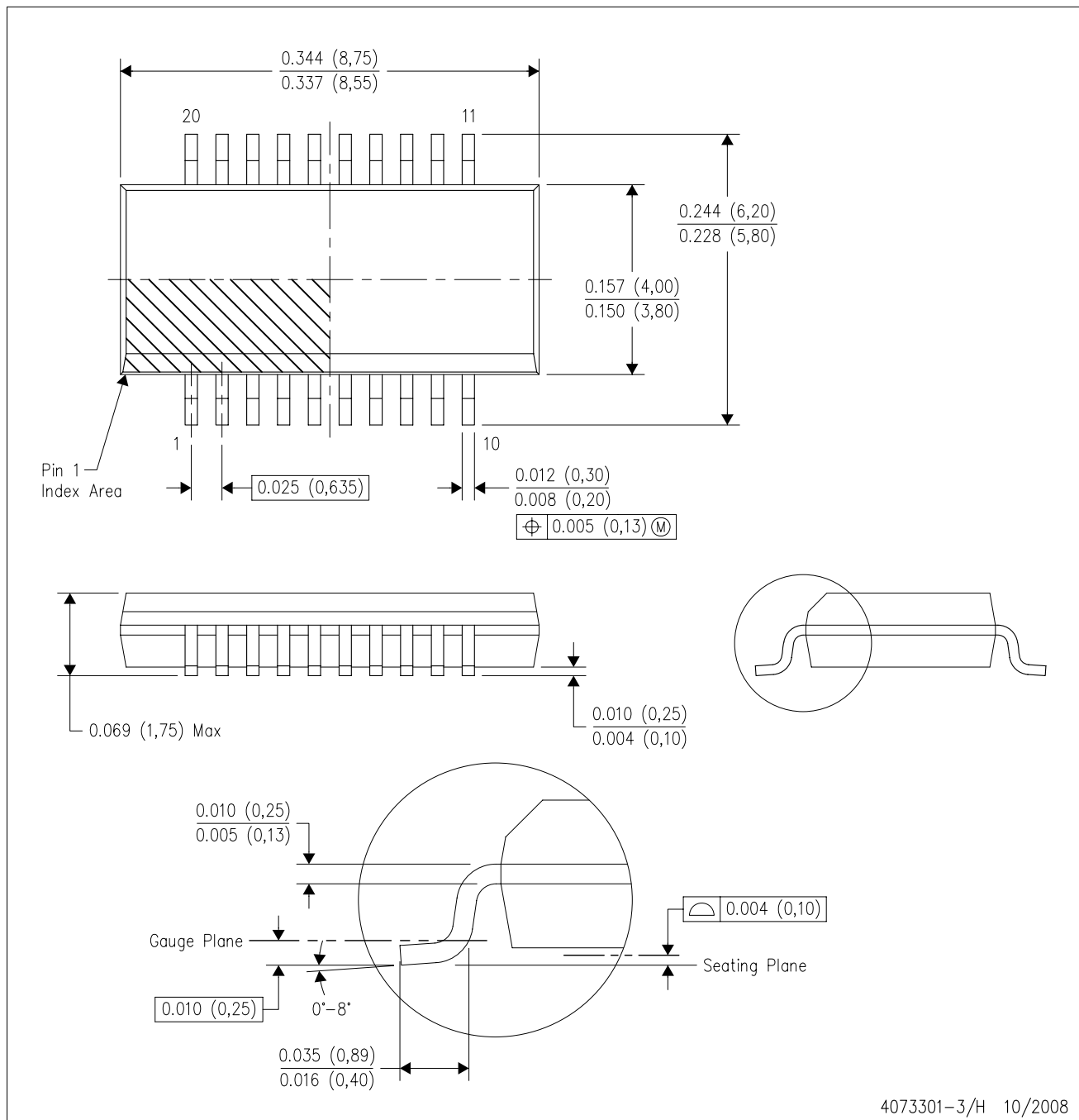
4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

DBQ (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15) per side.
  - D. Falls within JEDEC MO-137 variation AD.

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